

Thyristor \ Diode Module

$V_{RRM} = 2 \times 1800 \text{ V}$

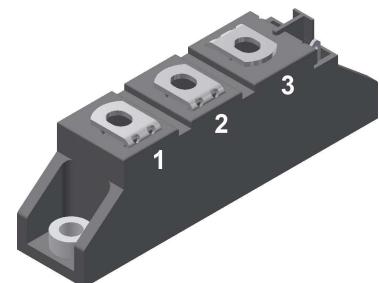
$I_{TAV} = 85 \text{ A}$

$V_T = 1.34 \text{ V}$

Phase leg

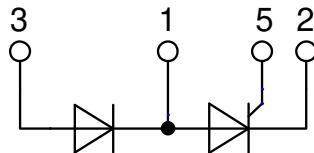
Part number

MCD72-18io8B



Backside: isolated

 E72873



Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al₂O₃-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: TO-240AA

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Disclaimer Notice

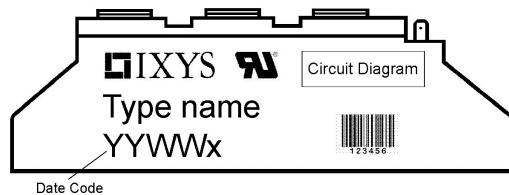
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Rectifier

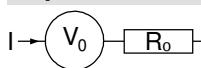
Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM/DSM}$	max. non-repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ C$			1900	V
$V_{RRM/DRM}$	max. repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ C$			1800	V
$I_{R/D}$	reverse current, drain current	$V_{R/D} = 1800 V$ $V_{R/D} = 1800 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		200 5	μA mA
V_T	forward voltage drop	$I_T = 150 A$	$T_{VJ} = 25^\circ C$		1.34	V
		$I_T = 300 A$			1.74	V
		$I_T = 150 A$	$T_{VJ} = 125^\circ C$		1.34	V
		$I_T = 300 A$			1.82	V
I_{TAV}	average forward current	$T_C = 85^\circ C$	$T_{VJ} = 125^\circ C$		85	A
$I_{T(RMS)}$	RMS forward current	180° sine			133	A
V_{T0}	threshold voltage	r_T slope resistance } for power loss calculation only	$T_{VJ} = 125^\circ C$		0.85	V
	slope resistance				3.2	$m\Omega$
R_{thJC}	thermal resistance junction to case				0.3	K/W
R_{thCH}	thermal resistance case to heatsink			0.2		K/W
P_{tot}	total power dissipation		$T_C = 25^\circ C$		333	W
I_{TSM}	max. forward surge current	$t = 10 ms; (50 Hz)$, sine	$T_{VJ} = 45^\circ C$		1.70	kA
		$t = 8,3 ms; (60 Hz)$, sine	$V_R = 0 V$		1.84	kA
		$t = 10 ms; (50 Hz)$, sine	$T_{VJ} = 125^\circ C$		1.45	kA
		$t = 8,3 ms; (60 Hz)$, sine	$V_R = 0 V$		1.56	kA
I^2t	value for fusing	$t = 10 ms; (50 Hz)$, sine	$T_{VJ} = 45^\circ C$		14.5	kA^2s
		$t = 8,3 ms; (60 Hz)$, sine	$V_R = 0 V$		14.0	kA^2s
		$t = 10 ms; (50 Hz)$, sine	$T_{VJ} = 125^\circ C$		10.4	kA^2s
		$t = 8,3 ms; (60 Hz)$, sine	$V_R = 0 V$		10.1	kA^2s
C_J	junction capacitance	$V_R = 400 V$ $f = 1 MHz$	$T_{VJ} = 25^\circ C$	119		pF
P_{GM}	max. gate power dissipation	$t_p = 30 \mu s$	$T_C = 125^\circ C$		10	W
		$t_p = 300 \mu s$			5	W
					0.5	W
P_{GAV}	average gate power dissipation					
$(di/dt)_{cr}$	critical rate of rise of current	$T_{VJ} = 125^\circ C$; $f = 50 Hz$	repetitive, $I_T = 250 A$		150	$A/\mu s$
		$t_p = 200 \mu s$; $di_G/dt = 0.45 A/\mu s$				
		$I_G = 0.45 A$; $V = \frac{2}{3} V_{DRM}$	non-repet., $I_T = 85 A$		500	$A/\mu s$
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{VJ} = 125^\circ C$		1000	$V/\mu s$
		$R_{GK} = \infty$; method 1 (linear voltage rise)				
V_{GT}	gate trigger voltage	$V_D = 6 V$	$T_{VJ} = 25^\circ C$		2.5	V
			$T_{VJ} = -40^\circ C$		2.6	V
I_{GT}	gate trigger current	$V_D = 6 V$	$T_{VJ} = 25^\circ C$		150	mA
			$T_{VJ} = -40^\circ C$		200	mA
V_{GD}	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = 125^\circ C$		0.2	V
I_{GD}	gate non-trigger current				10	mA
I_L	latching current	$t_p = 10 \mu s$ $I_G = 0.45 A$; $di_G/dt = 0.45 A/\mu s$	$T_{VJ} = 25^\circ C$		450	mA
I_H	holding current	$V_D = 6 V$ $R_{GK} = \infty$	$T_{VJ} = 25^\circ C$		200	mA
t_{gd}	gate controlled delay time	$V_D = \frac{1}{2} V_{DRM}$	$T_{VJ} = 25^\circ C$		2	μs
		$I_G = 0.45 A$; $di_G/dt = 0.45 A/\mu s$				
t_q	turn-off time	$V_R = 100 V$; $I_T = 150 A$; $V = \frac{2}{3} V_{DRM}$ $T_{VJ} = 100^\circ C$ $di/dt = 10 A/\mu s$ $dv/dt = 20 V/\mu s$ $t_p = 200 \mu s$		185		μs

Package TO-240AA

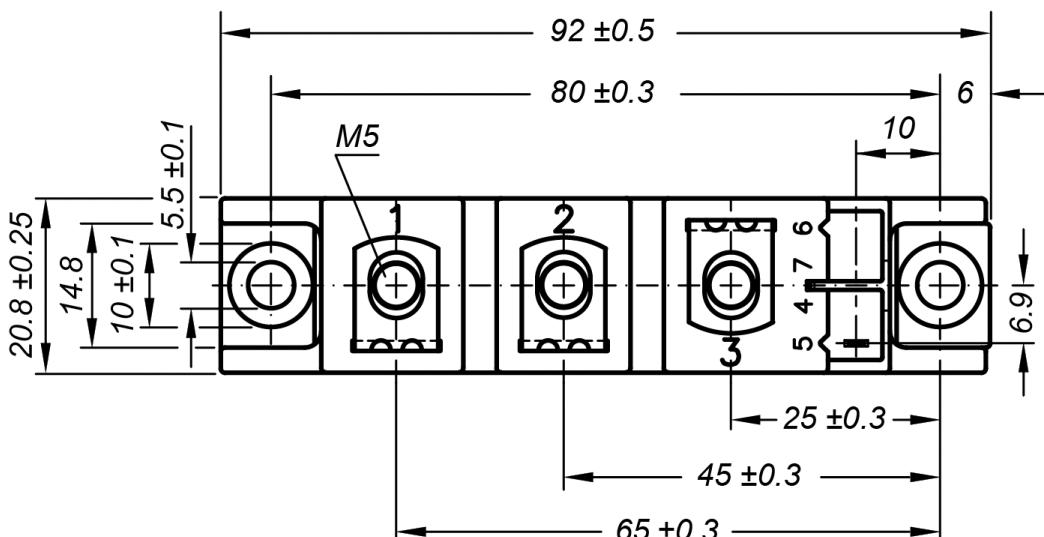
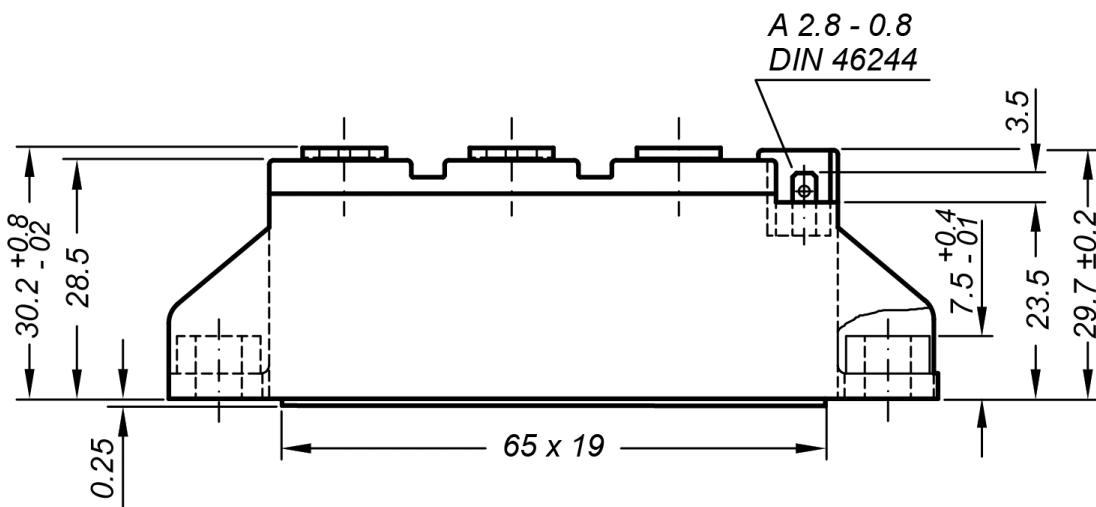
Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
I_{RMS}	<i>RMS current</i>	per terminal			200	A
T_{VJ}	<i>virtual junction temperature</i>		-40		125	°C
T_{op}	<i>operation temperature</i>		-40		100	°C
T_{stg}	<i>storage temperature</i>		-40		125	°C
Weight				81		g
M_D	<i>mounting torque</i>		2.5		4	Nm
M_T	<i>terminal torque</i>		2.5		4	Nm
$d_{Spp/App}$	<i>creepage distance on surface / striking distance through air</i>		<i>terminal to terminal</i>	13.0	9.7	mm
$d_{Spb/Apb}$			<i>terminal to backside</i>	16.0	16.0	mm
V_{ISOL}	<i>isolation voltage</i>	$t = 1 \text{ second}$ $t = 1 \text{ minute}$ 50/60 Hz, RMS; $I_{ISOL} \leq 1 \text{ mA}$		4800 4000		V V



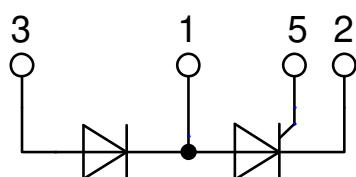
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCD72-18io8B	MCD72-18io8B	Box	36	454486

Equivalent Circuits for Simulation
* on die level
 $T_{VJ} = 125^\circ\text{C}$

Thyristor

$V_{0\max}$ threshold voltage 0.85 V
 $R_{0\max}$ slope resistance * 2 mΩ

Outlines TO-240AA

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red
Type ZY 200L (L = Left for pin pair 4/5) UL 758, style 3751



Thyristor

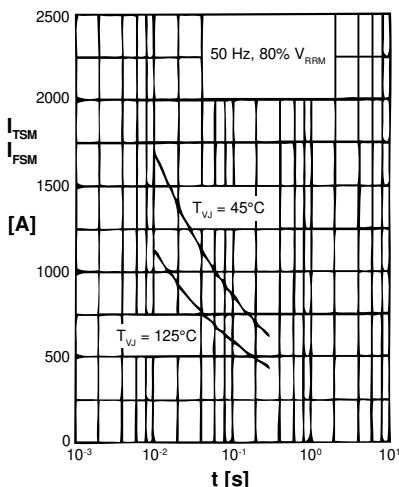


Fig. 1 Surge overload current
 I_{TSM}, I_{FSM} : Crest value, t : duration

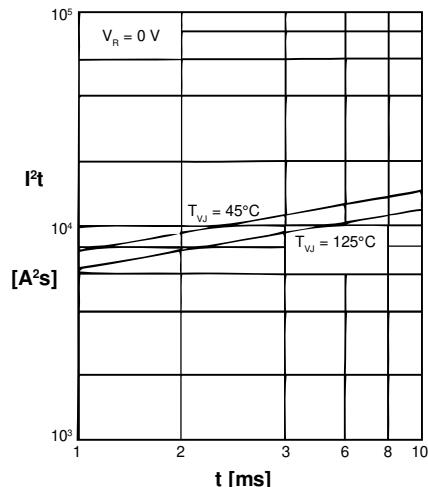


Fig. 2 I^2t versus time (1-10 ms)

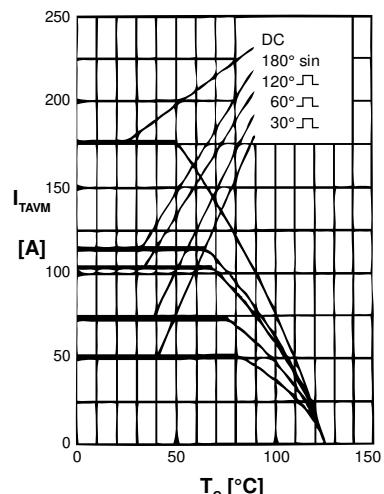


Fig. 3 Maximum forward current at case temperature

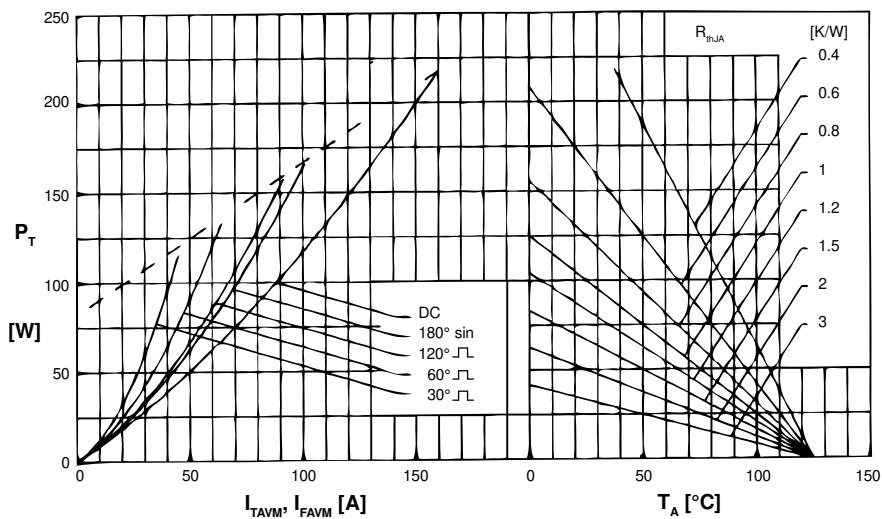


Fig. 4 Power dissipation vs. onstate current and ambient temperature (per thyristor/diode)

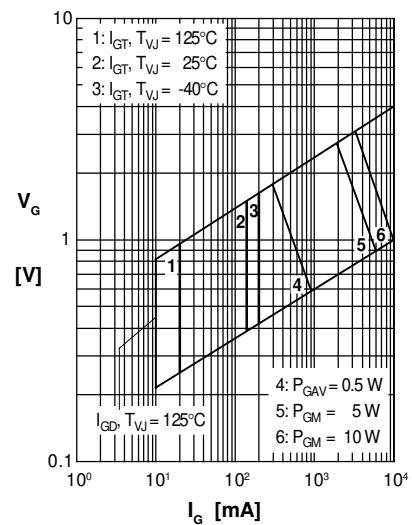


Fig. 5 Gate trigger characteristics

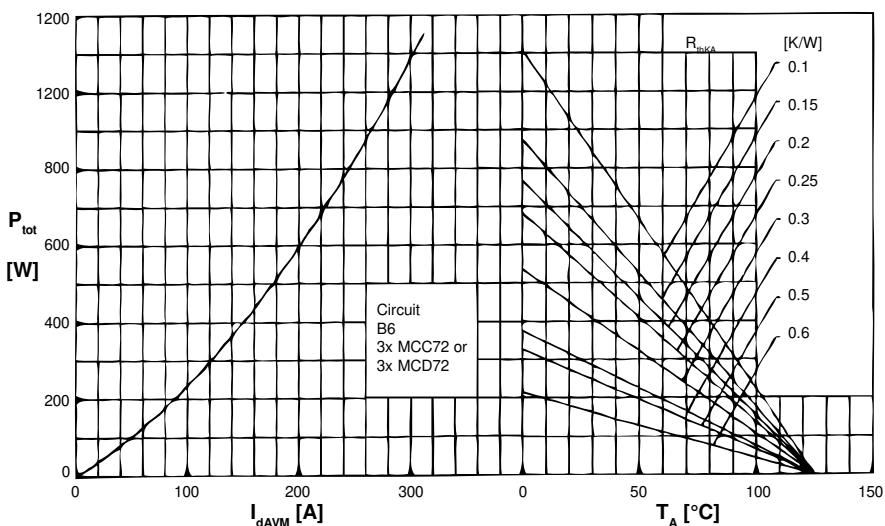


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

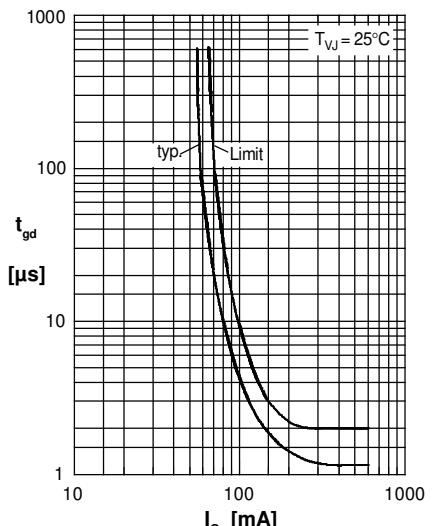


Fig. 7 Gate trigger delay time

Rectifier

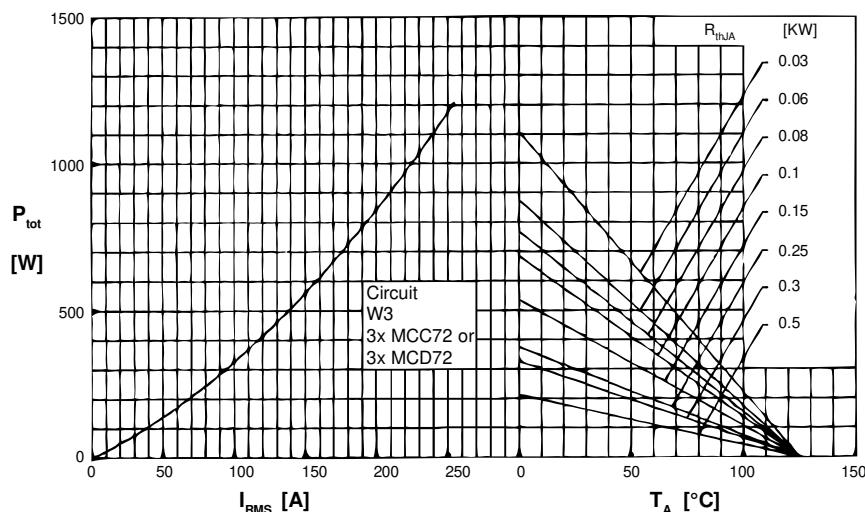


Fig. 8 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

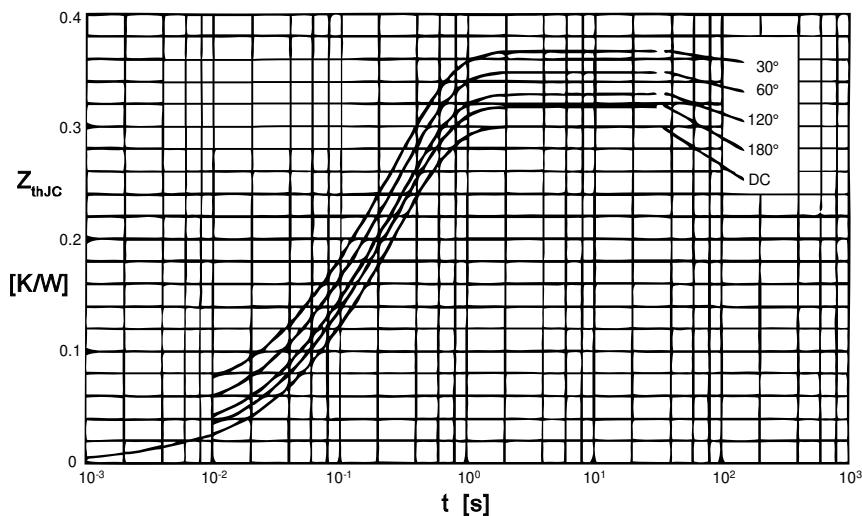


Fig. 9 Transient thermal impedance junction to case (per thyristor)

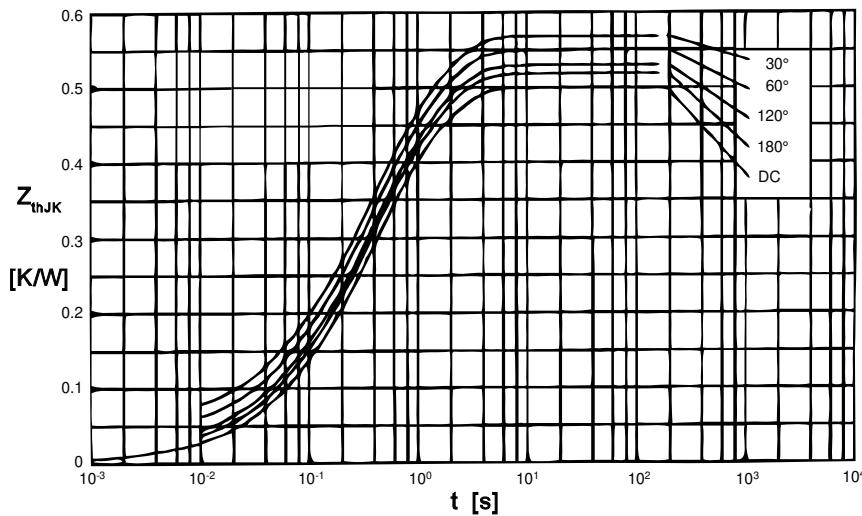


Fig. 10 Transient thermal impedance junction to heatsink (per thyristor)

R_{thJC} for various conduction angles d:

d R_{thJC} [K/W]

DC 0.30

180° 0.31

120° 0.33

60° 0.35

30° 0.37

Constants for Z_{thJC} calculation:

i R_{thi} [K/W] t_i [s]

1 0.008 0.0019

2 0.054 0.0470

3 0.238 0.3000

R_{thJK} for various conduction angles d:

d R_{thJK} [K/W]

DC 0.50

180° 0.51

120° 0.53

60° 0.55

30° 0.57

Constants for Z_{thJK} calculation:

i R_{thi} [K/W] t_i [s]

1 0.008 0.0019

2 0.054 0.0470

3 0.238 0.3000

4 0.200 1.2500